



N-Channel 40-V (D-S) 175 °C MOSFET

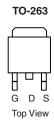
PRODUCT SUMMARY					
V _{(BR)DSS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
40	0.0031 at V _{GS} = 10 V	110 ^a			

FEATURES

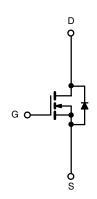
- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- Package with Low Thermal Resistance
- Extremely Low Q_{gd} WFET[™] Technology for Low Switching Losses
- 100 % R_g Tested







Ordering Information: SUM110N04-03P-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS To	= 25 °C, unless other	wise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1-	110 ^a		
	T _C = 125 °C	I _D	110 ^a	_	
Pulsed Drain Current		I _{DM}	440	A	
Avalanche Current	L = 0.1 mH	I _{AS}	70		
Single Pulse Avalanche Energy ^b	L = 0.1 IIII	E _{AS}	211	mJ	
Mariana Barra Birata da b	T _C = 25 °C	PD	375 ^c	w	
Maximum Power Dissipation ^b	T _A = 25 °C	'	3.75	\\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\	
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount ^d	R_{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4]	

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

SUM110N04-03P

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	40			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА	
	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50		
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.0025	0.0031	Ω	
	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.0049		
		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175 ^{\circ}\text{C}$			0.0059		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$	30			S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		6500		pF	
Output Capacitance	C _{oss}			1400			
Reverse Transfer Capacitance	C _{rss}			570			
Total Gate Charge ^c	Q_g			90	150	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$		35			
Gate-Drain Charge ^c	Q_{gd}			22			
Gate Resistance	R_{g}	f = 1 MHz	0.5	1.1	1.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			145	220	ns	
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.27 Ω $I_D \cong 110$ A, V_{GEN} = 10 V, R_G = 2.5 Ω		35	55		
Turn-Off Delay Time ^c	t _{d(off)}			20	30		
Fall Time ^c	t _f			55	85		
Source-Drain Diode Ratings and Ch	aracteristics 7	C _C = 25 °C ^b					
Continuous Current	I _S	6			110		
Pulsed Current	I _{SM}				240	A	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.1	1.5	V	
Reverse Recovery Time	t _{rr}			60	90	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 85 A, di/dt = 100 A/μs		2.5	5	Α	
Reverse Recovery Charge	Q _{rr}			0.075	0.22	μC	

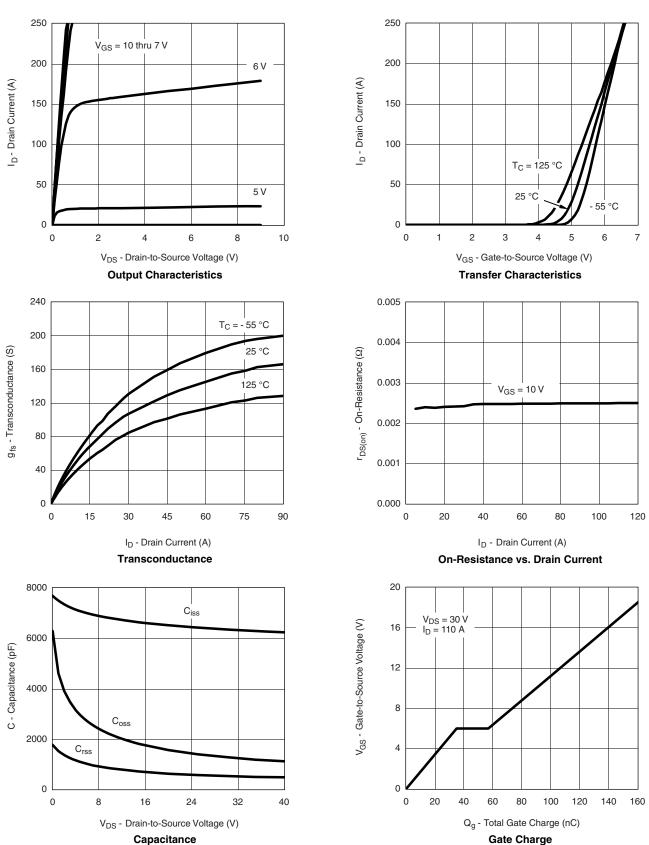
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



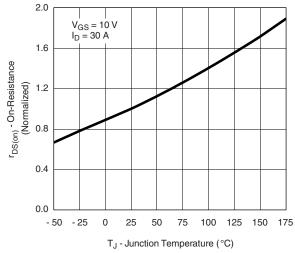
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



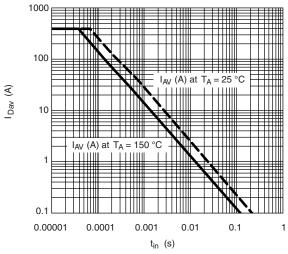
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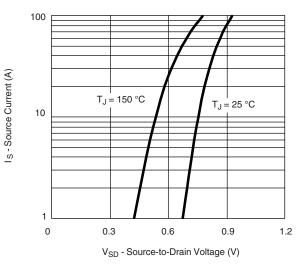
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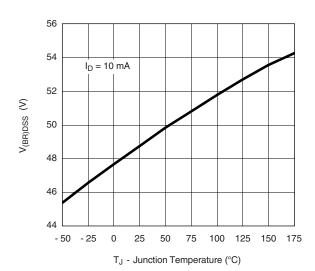
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



Source-Drain Diode Forward Voltage

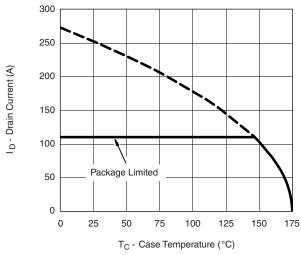


Drain Source Breakdown vs. Junction Temperature

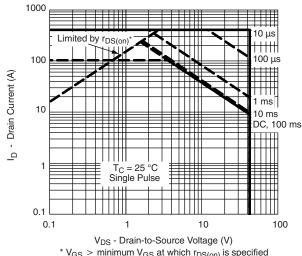




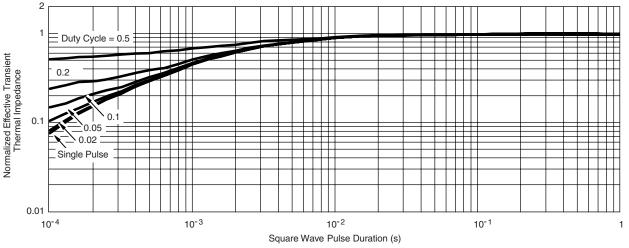
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



* V_{GS} > minimum V_{GS} at which $r_{DS(on)}$ is specified Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

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